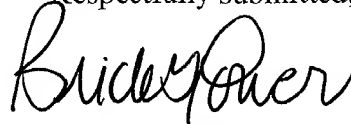


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REMARKS

No new matter has been added. The Applicants again request entry of the amendments as set forth in the Appendices hereto prior to examination of the application on the merits.

Respectfully submitted,



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Date: July 9, 2001

BGP/dn

Enclosure: Version of Specification with Markings to Show Changes Made
 Version of Claims with Markings to Show Changes Made

Serial No.: 09/832,160

VERSION OF SPECIFICATION WITH MARKINGS TO SHOW CHANGES MADE

Please replace the heading between the title "WAFER-LEVEL PACKAGE AND METHODS OF FABRICATING" and Paragraph [0001] with the following:

CROSS-REFERENCE TO RELATED [APPLICATIONS] APPLICATION

Serial No.: 09/832,160

VERSION OF CLAIMS WITH MARKINGS TO SHOW CHANGES MADE

CLAIMS

What is claimed is:

[CLAIMS FOR CON OF 2269-3846US]

5. (Amended) The method of claim [7]3, wherein said defining is effected before said positioning.
20. (Amended) The method of claim 17, further comprising placing polymeric material at least laterally adjacent said [at least one]conductive structure.
22. (Amended) The method of claim 21, further comprising placing another conductive structure in contact with said conductive elastomer, opposite said at least one conductive structure.